

Quad TTL/NMOS to PECL* Translator

Description

The MC10H351 is a quad translator for interfacing data between a saturated logic section and the PECL section of digital systems when only a +5.0 Vdc power supply is available. The MC10H351 has TTL/NMOS compatible inputs and PECL complementary open-emitter outputs that allow use as an inverting/non-inverting translator or as a differential line driver. When the common strobe input is at a low logic level, it forces all true outputs to the PECL low logic state ($\approx +3.2$ V) and all inverting outputs to the PECL high logic state ($\approx +4.1$ V).

The MC10H351 can also be used with the MC10H350 to transmit and receive TTL/NMOS information differentially via balanced twisted pair lines.

Features

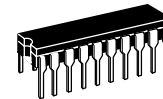
- Single +5.0 Power Supply
- All V_{CC} Pins Isolated On Chip
- Differentially Drive Balanced Lines
- $t_{pd} = 1.3$ nsec Typical
- Pb-Free Packages are Available*



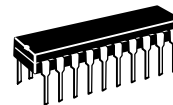
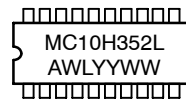
ON Semiconductor®

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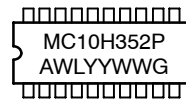
MARKING DIAGRAMS*



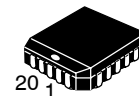
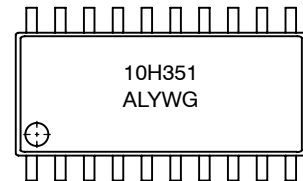
CDIP-20
L SUFFIX
CASE 732



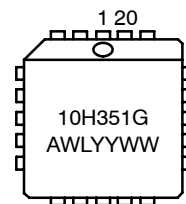
PDIP-20
P SUFFIX
CASE 738



SOEIAJ-20
CASE 967



PLLC-20
FN SUFFIX
CASE 775



A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G = Pb-Free Package

*For additional marking information, refer to Application Note AND8002/D.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

MC10H351

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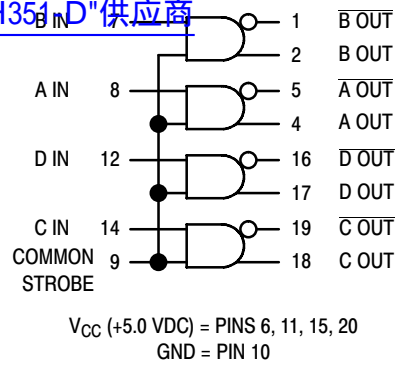
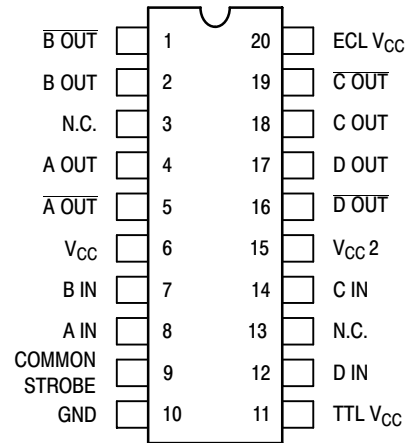


Figure 1. Logic Diagram



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

Figure 2. Dip Pin Assignment

Table 1. MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
V_{CC}	Power Supply	0 to +7.0	Vdc
V_I	Input Voltage ($V_{CC} = 5.0$ V)	0 to V_{CC}	Vdc
I_{out}	Output Current – Continuous – Surge	50 100	mA
T_A	Operating Temperature Range	0 to +75	°C
T_{stg}	Storage Temperature Range – Plastic – Ceramic	–55 to +150 –55 to +165	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

MC10H351

Table 2. ELECTRICAL CHARACTERISTICS ($V_{CC} = V_{CC1} = V_{CC2} = 5.0 \text{ V} \pm 5.0\%$)†

Symbol	Characteristic	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
ECL	Power Supply	–	50	–	45	–	50	mA
TTL	Current	–	20	–	15	–	20	mA
I_R	Reverse Current	–	25	–	20	–	25	μA
I_{INH}	Pins 7, 8, 12, 14 Pin 9	–	100	–	80	–	100	
I_F	Forward Current	–	–0.8	–	–0.6	–	–0.8	mA
I_{INL}	Pins 7, 8, 12, 14 Pin 9	–	–3.2	–	–2.4	–	–3.2	
$V_{(BR)in}$	Input Breakdown Voltage	5.5	–	5.5	–	5.5	–	Vdc
V_I	Input Clamp Voltage ($I_{in} = -18 \text{ mA}$)	–	–1.5	–	–1.5	–	–1.5	Vdc
V_{OH}	High Output Voltage (Note 1.)	3.98	4.16	4.02	4.19	4.08	4.27	Vdc
V_{OL}	Low Output Voltage (1)	3.05	3.37	3.05	3.37	3.05	3.37	Vdc
V_{IH}	High Input Voltage	2.0	–	2.0	–	2.0	–	Vdc
V_{IL}	Low Input Voltage	–	0.8	–	0.8	–	0.8	Vdc

†Each MECL 10H™ series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50 Ω resistor to $V_{CC} - 2.0 \text{ Vdc}$.

*Positive Emitter Coupled Logic

1. With V_{CC} at 5.0 V. V_{OH}/V_{OL} change 1:1 with V_{CC} .

Table 3. AC PARAMETERS

Symbol	Characteristic	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
t_{pd}	Propagation Delay (Note 2)	0.4	2.2	0.4	2.2	0.4	2.1	ns
t_r	Rise Time (20% to 80%)	0.4	1.9	0.4	2.0	0.4	2.1	ns
t_f	Fall Time (80% to 20%)	0.4	1.9	0.4	2.0	0.4	2.1	ns
f_{max}	Maximum Operating Frequency	150	–	150	–	150	–	MHz

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

2. Propagation delay is measured on this circuit from +1.5 V on the input waveform to the 50% point on the output waveform.

MC10H351

ORDERING INFORMATION
[查询 MC10H351-D 供应商](#)

Device	Package	Shipping†
MC10H351FN	PLLC-20	46 Units / Rail
MC10H351FNG	PLLC-20 (Pb-Free)	46 Units / Rail
MC10H351FNR2	PLLC-20	500 / Tape & Reel
MC10H351FNR2G	PLLC-20 (Pb-Free)	500 / Tape & Reel
MC10H351L	CDIP-20	25 Unit / Rail
MC10H351M	SOEIAJ-20	40 Unit / Rail
MC10H351MG	SOEIAJ-20 (Pb-Free)	40 Unit / Rail
MC10H351MEL	SOEIAJ-20	2000 / Tape & Reel
MC10H351MELG	SOEIAJ-20 (Pb-Free)	2000 / Tape & Reel
MC10H351P	PDIP-20	18 Unit / Rail
MC10H351PG	PDIP-20 (Pb-Free)	18 Unit / Rail

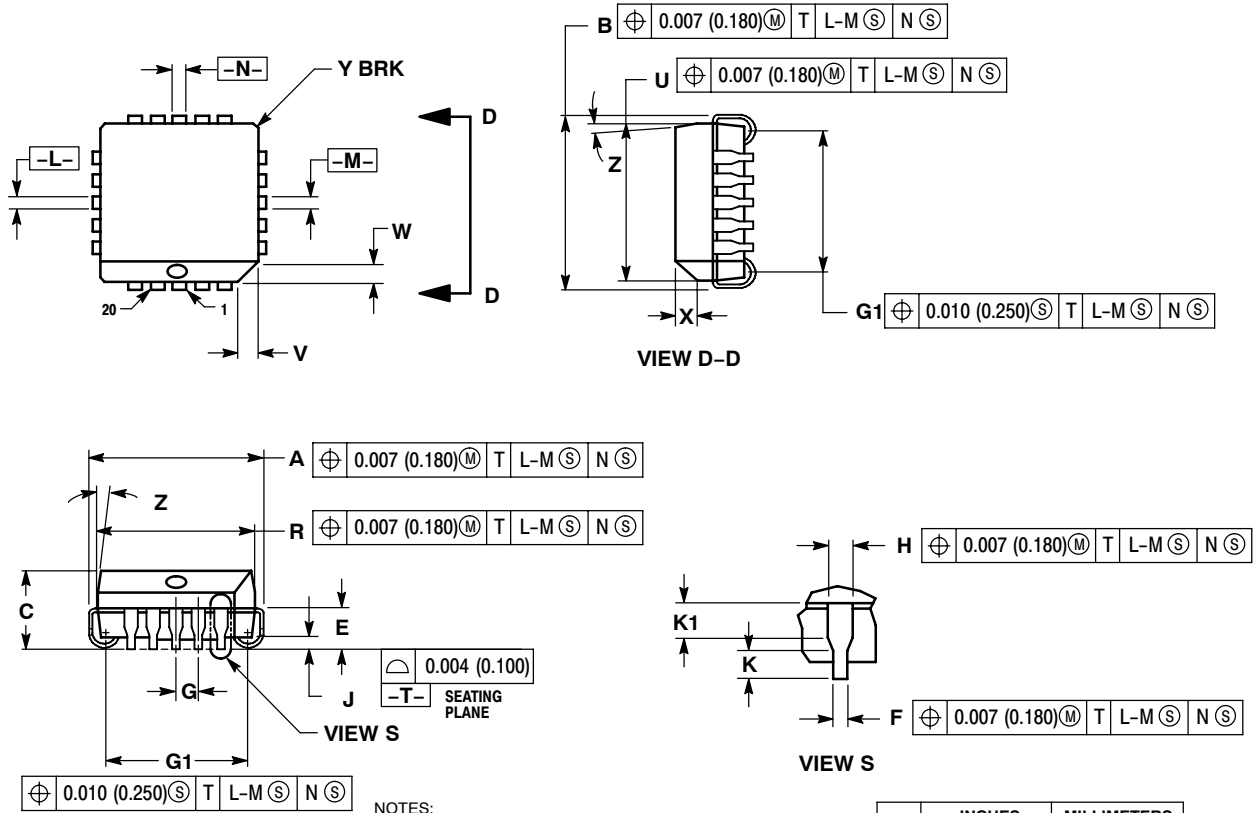
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MC10H351

[查询"MC10H351-D"供应商](#)

PACKAGE DIMENSIONS

20 LEAD PLLC
CASE 775-02
ISSUE E



NOTES:

- DIMENSIONS AND TOLERANCING PER ANSI Y14.5M, 1982.
- DIMENSIONS IN INCHES.
- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONS IN THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

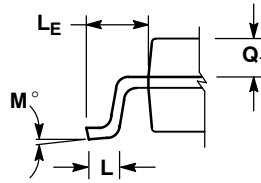
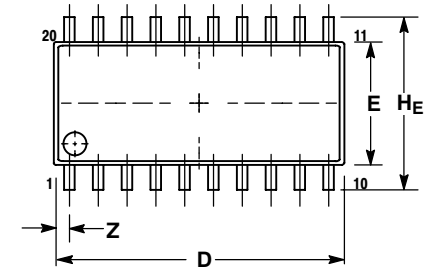
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2 °	10 °	2 °	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040	---	1.02	---

MC10H351

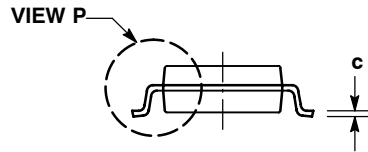
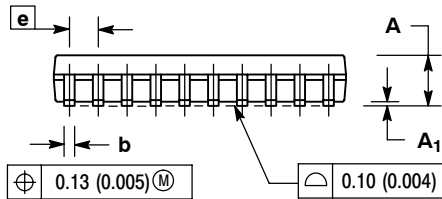
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PACKAGE DIMENSIONS

SOEIAJ-20 CASE 967-01 ISSUE A



DETAIL P

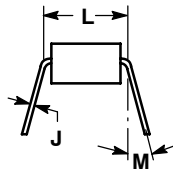
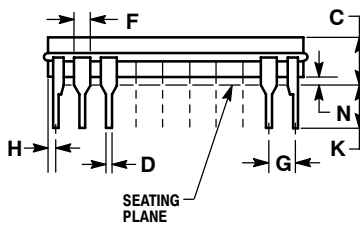
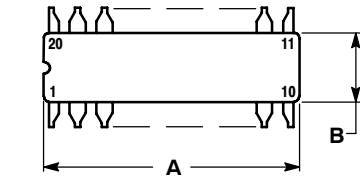


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	---	2.05	---	0.081
A ₁	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.15	0.25	0.006	0.010
D	12.35	12.80	0.486	0.504
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H _E	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
L _E	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q ₁	0.70	0.90	0.028	0.035
Z	---	0.81	---	0.032

CDIP-20 L SUFFIX CERAMIC DIP PACKAGE CASE 732-03 ISSUE E



NOTES:

1. LEADS WITHIN 0.010 DIAMETER, TRUE POSITION AT SEATING PLANE, AT MAXIMUM MATERIAL CONDITION.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSIONS A AND B INCLUDE MENISCUS.

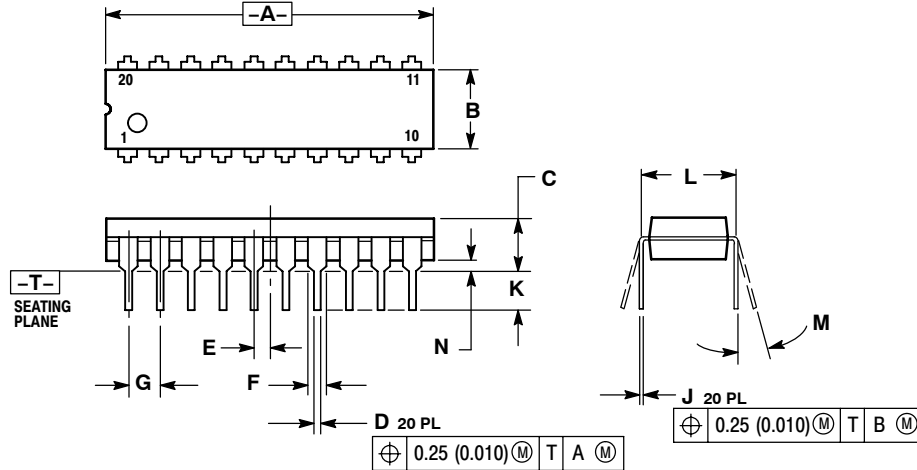
DIM	INCHES	
	MIN	MAX
A	0.940	0.990
B	0.260	0.295
C	0.150	0.200
D	0.015	0.022
F	0.055	0.065
G	0.100 BSC	
H	0.020	0.050
J	0.008	0.012
K	0.125	0.160
L	0.300 BSC	
M	0°	15°
N	0.010	0.040

MC10H351

[查询"MC10H351-D"供应商](#)

PACKAGE DIMENSIONS

PDIP-20
P SUFFIX
PLASTIC DIP PACKAGE
CASE 738-03
ISSUE E




NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.010	1.070	25.66	27.17
B	0.240	0.260	6.10	6.60
C	0.150	0.180	3.81	4.57
D	0.015	0.022	0.39	0.55
E	0.050 BSC		1.27 BSC	
F	0.050	0.070	1.27	1.77
G	0.100 BSC		2.54 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.140	2.80	3.55
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

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